Panasonic CONNECT



Windows 11 Pro Fully Rugged Laptop with 14.0" Outdoor Display and Modular Expansion Areas.

TOUGHBOOK 40 mk2

The 14.0" fully-rugged Panasonic TOUGHBOOK 40 laptop breaks new ground offering unrivaled flexibility in even the most demanding and unpredictable environments, including Defence, Mining and Utilities. It has a modular design that allows mobile workers to modify the device quickly and easily for different challenges by equipping 8 expansion areas. The powerful rugged laptop is built for use in the most extreme conditions and designed for field specialists, incorporating quick release self-encrypting secure drives and providing up to 36-hours of battery life to support mission critical operations.

Key Features

Intel® Core™ Ultra5 135H Processor (with Intel vPro® Technology) / Intel® Core™ Ultra7 165H (with Intel vPro® Technology) Processor

Windows 11 Pro

14.0" Active Matrix (TFT) colour LCD 1920 x 1080 (FHD) with sunlight-viewable glove-enabled touchscreen (up to 1,200cd/m²)

Up to 180cm drop resistance***, IP66 water and dust resistance, MIL-STD 810H certified***

Long battery life of up to 18 hours (up to 36 hours with optional 2nd battery*)









TOUGHBOOK 40 mk2

https://ap.connect.panasonic.com/id/ /en/toughbook-40-mk2



AC Adapter

Battery Life

Power Management

Dimensions (WxHxD)

Drop Resistance

Dust Resistance

Water Resistance

Operating Temperature Standard Configuration

Battery

Weight





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Mobile Computing Platform	Intel® Core™ Ultra5 135H Processor (with Intel vPro® Technology) / Intel® Core™ Ultra7				
Operating System	165H (with Intel vPro® Technology) Processor Windows 11 Pro				
RAM	Built-in 16GB RAM (max 64GB RAM*)				
Graphic Chip	Intel® Graphics (Built-in CPU), support Intel® Arc™ Graphics when equipped with 2 R				
ar aprile emp	modules				
Storage	Quick release 512GB NVMe OPAL SSD (with heater). Optional 2nd SSD*				
LCD	14.0" Active Matrix (TFT) colour LCD 1920 x 1080 (FHD) LCD with sunlight-viewable glove- enabled touchscreen (up to 1,200cd/m² brightness)				
Bluetooth™	5.1 Class 1				
Wireless LAN	Intel® Wi-Fi6 AX201				
Mobile Broadband*	4G LTE				
GPS*	U-Blox NEO-M8J				
LAN	IEEE 802.3 10Base-T / IEEE 802.3u 100BASE-TX / IEEE 802.3ab 1000BASE-T (optional 2nd				
Sound	GLAN*) Wayor MayyAudio® Storog Speakers				
sound	Waves MaxxAudio® Stereo Speakers				
	4 integrated microphones				
Security	TPM 2.0, Password security, Integrated hardware security lock slot				
Front Camera	5MP with IR / privacy shutter (Windows Hello compliant) optional*				
USB 3.2	x2 (Gen 1 Type-A)				
Thunderbolt 4	x1				
Micro SDXC Memory Card	x1				
HDMI	x1				
Headset	x1				
DC In	x1				
Port Replicator	x1				
Quad Path Through Connector	x1				
Left Expansion Area**	2nd SSD,				
	Smart Card Reader,				
	DVD Multi Drive,				
	Blu Ray Drive.				
Right Expansion Area**	2nd Battery,				
	Smart Card Reader.				
Rear Expansion Area**	VGA + True Serial (RS232) + 2nd native GLAN,				
	USB 3.1 Type A + True Serial (RS232) + 2nd HDMI,				
	USB 3.1 Type A + USB 3.1 Type A + 2nd HDMI.				
Palm Rest Expansion Area**	Fingerprint reader (Windows Hello),				
	Fingerprint reader (Windows Hello, Multi-user authentication),				

Contactless Smart Card Reader.

Standby function, ACPI BIOS

MIL-STD810H, 180cm***

MIL-STD810H, -29°C to +63°C***

IP6x

Input: 100V - 240V AC, 50Hz/ 60Hz, Output: 15.6V DC, 7.05A

With optional 2nd battery: approx 36 hours (Mobile Mark™ 2014)*

TOUGHBOOK 40 mk2, 16GB RAM, 512GB SSD, 1 x standard battery pack

Lithium-Ion 10.8V, 6500mAh (typical), 6300mAh (minimum)

354mm x 301mm x 54.4mm (without protruding parts)

Approx 3.35kg (depending on configuration)

Standard: approx 18 hours (Mobile Mark™ 2014),

Included in the box	Power Supply, Power Cord, Capacitive Stylus Pen, Display Cleaning Cloth and User Manual		
Footnote	*Optional		
	**One option exclusive possible in configuration port / business expansion module		

***Tested by an independent third party lab following MIL-STD810H Method 516.8 Procedure IV for transit drop test and Method 501.7 and 502.7 Procedure II for operation temperature test. May differ depending on models and options